

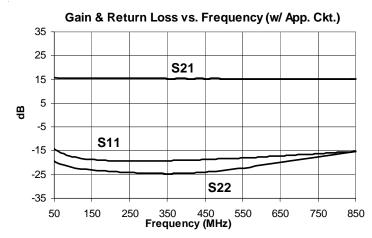
Product Description

Test Conditions:

 $T_L = 25^{\circ}C$

Sirenza Microdevices' SBB-1089Z is a high performance InGaP HBT MMIC amplifier utilizing a Darlington configuration with an active bias network. The active bias network provides stable current over temperature and process Beta variations. Designed to run directly from a 5V supply, the SBB-1089Z does not require a dropping resistor as compared to typical Darlington amplifiers. The SBB-1089Z product is designed for high linearity 5V gain block applications that require small size and minimal external components. It is internally matched to 50 ohms.

The matte tin finish on Sirenza's lead-free package utilizes a post annealing process to mitigate tin whisker formation and is RoHS compliant per EU Directive 2002/95. This package is also manufactured with green molding compounds that contain no antimony trioxide nor halogenated fire retardants.



SBB-1089Z

50 - 850 MHz, Cascadable Active Bias InGaP HBT MMIC Amplifier





Product Features

- OIP3 = 43.1 dBm @ 240MHz
- P1dB = 19.6 dBm @ 500MHz
- Single Fixed 5V Supply
- Robust 1000V ESD, Class 1C
- Patented Thermal Design & Bias Circuit
- Low Thermal Resistance
- MSL 1 moisture rating

Applications

- Receiver IF Amplifier
- Cellular, PCS, GSM, UMTS
- · Wireless Data, Satellite Terminals

OIP₃ Tone Spacing = 1MHz, Pout per tone = 0 dBm

Symbol	Parameters	Units	Frequency	Min.	Тур.	Max.
			70 MHz		15.5	
S ₂₁	Small Signal Gain	dB	240 MHz	14	15.5	17
			400 MHz	14	15.5	17
			70 MHz		19	
P_{1dB}	Output Power at 1dB Compression	dBm	240 MHz		19	
			400 MHz	18	19	
			70 MHz		42	
IP ₃	Third Order Intercept Point	dBm	240 MHz		43	
			400 MHz	38.5	40.5	
Bandwidth	S ₁₁ , S ₂₂ : Minimum 10dB Return Loss (typ.)	MHz			50 - 850	
IRL	Input Return Loss	dB	70 -500MHz	14	18	
ORL	Output Return Loss	dB	70 -500MHz	12	16	
S ₁₂	Reverse Isolation	dB	70 -500MHz		18	
NF	Noise Figure	dB	500 MHz		3.5	4.2
V_D	Device Operating Voltage	V			5	5.3
I _D	Device Operating Current	mA		82	90	98
R _{TH} , j-l	Thermal Resistance (junction - lead)	°C/W			48.8	

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Tested with Bias Tees

 $I_D = 90 \text{mA Typ.}$

 $Z_S = Z_L = 50 \text{ Ohms}$

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Broomfield, CO 80021

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BDS-103998 Rev D



Typical RF Performance at Key Operating Frequencies (With 240 MHz Application Circuit)

		Frequency (MHz)							
Symbol	Parameter	Unit	50	70	100	240	400	500	850
S ₂₁	Small Signal Gain	dB	16	15.5	15.5	15.5	15.5	15.5	15
OIP ₃	Output Third Order Intercept Point	dBm	41.5	42	43	43	41	40	35
P _{1dB}	Output Power at 1dB Compression	dBm	19	19	19	19	19	19	18
S ₁₁	Input Return Loss	dB	13	16	17	19	19	18	15
S ₂₂	Output Return Loss	dB	18	20	21	23	24	23	17
S ₁₂	Reverse Isolation	dB	18	18	18	18	18	18	18
NF	Noise Figure	dB	3.5	3.3	3.2	3.1	3.2	3.2	3.4

Test Conditions:

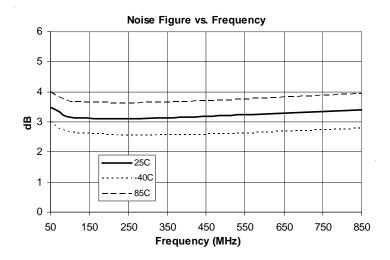
VCC = 5V

 $I_D = 90 \text{mA Typ.}$

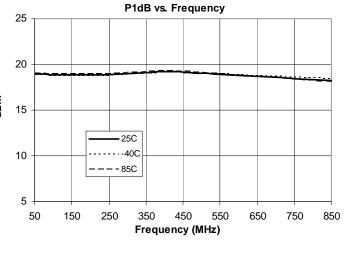
OIP₃ Tone Spacing = 1MHz, Pout per tone = 0 dBm

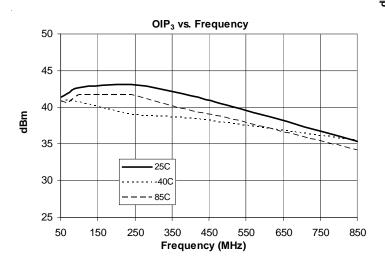
 $T_L = 25^{\circ}C$

 $Z_S = Z_L = 50 \text{ Ohms}$



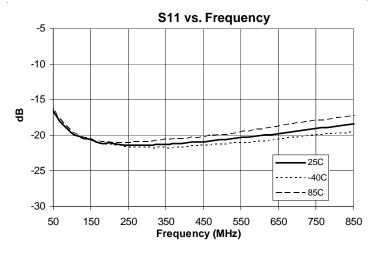
Data on Charts taken with 240 MHz App. Ckt.

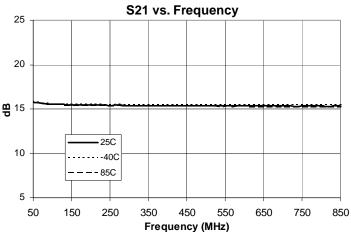


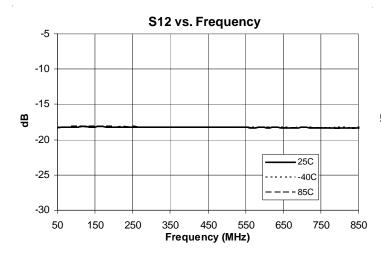


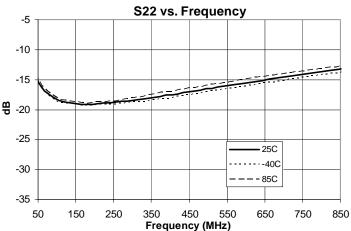


S-Parameters over Temperature (Bias Tee)

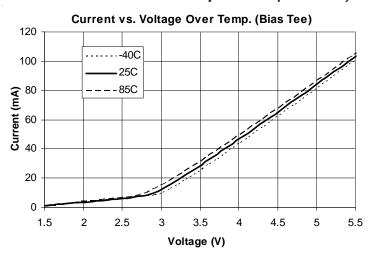






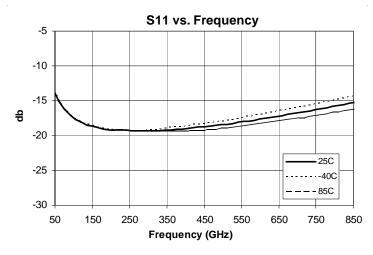


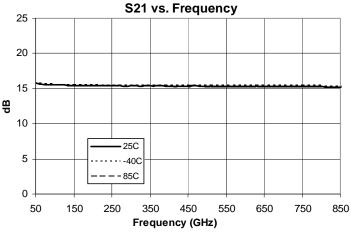
Device Current over Temperature (Bias Tee)

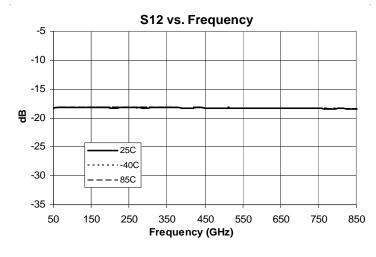


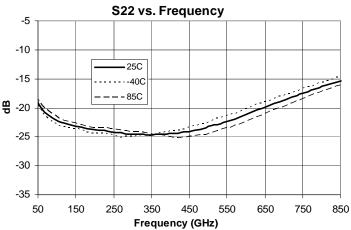


240 MHz Application Circuit S-Parameters over Temperature

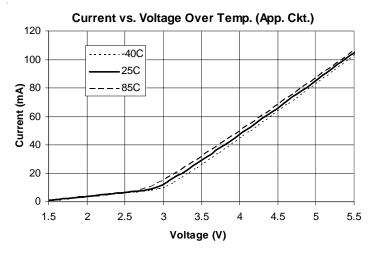








Device Current over Temperature (w/Application Circuit)

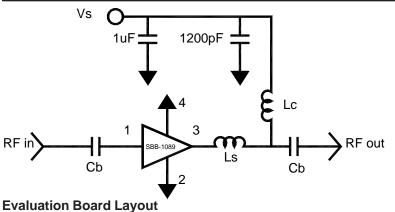


Phone: (800) SMI-MMIC 4



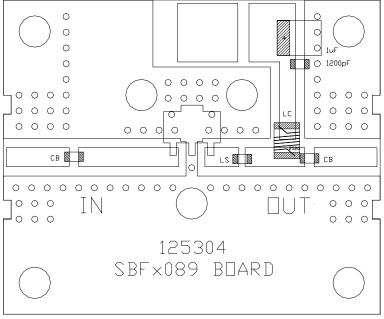
Application Schematic

Application Circuit Element Values



Reference Designator	Frequency (MHz) 50 to 850
C_B	8200pF
L _c	1200nH LS Coilcraft
Ls	2.7nH Toko

Absolute Maximum Ratings



Parameter	Absolute Limit
Ma. Dvice Current (I _D)	110 mA
Max Device Voltage (V _D)	5.5 V
Max. RF Input Power	+12 dBm
Max. Operating Dissipated Power	0.61 W
Max. Junction Temp. (T _J)	+150°C
Operating Temp. Range (T _L)	-40°C to +85°C
Max. Storage Temp.	+150°C

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one.

Bias Conditions should also satisfy the following expression: $I_DV_D < (T_J - T_L) \,/\, R_{TH},\, j\text{--}I \qquad T_L = T_{LEAD}$



ESD Class 1C

Appropriate precautions in handling, packaging and testing devices must be observed.

Mounting Instructions

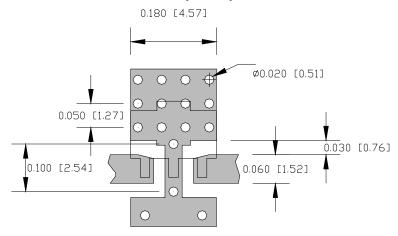
- 1. Solder the copper pad on the backside of the device package to the ground plane.
- 2. Use a large ground pad area with many plated through-holes as shown.
- 3. We recommend 1 or 2 ounce copper. Measurement for this datasheet were made on a 31 mil thick FR-4 board with 1 ounce copper on both sides.

MSL (Moisture Sensitivity Level) Rating: Level 1



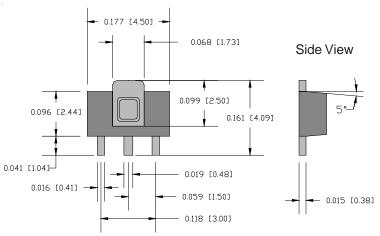
Suggested PCB Pad Layout

Dimensions in inches [millimeters]



Nominal Package Dimensions
Dimensions in inches (millimeters)
Refer to package drawing posted at www.sirenza.com for tolerances

Bottom View







Part Number Ordering Information

Part Number		Reel Size	Devices / Reel		
	SBB-1089Z	7"	1000		

Pin #	Function	Description
1	RF IN	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.
2, 4	GND	Connection to ground. Use via holes for best performance to reduce lead inductance as close to ground leads as possible.
3	RF OUT/ BIAS	RF output and bias pin. DC voltage is present on this pin, therefore a DC blocking capacitor is necessary for proper operation.